Our site is currently under maintenance

Please check out our introduction slides that follows



OMEC Intro





Overview

OMEC Shanghai factory

- LF/HF/UHF/Combo RFID and PCB card
- rPVC/PET/PC/PLA/Composite/Metal
- Custom printing
- DoD printing of white finished card
- Other form factors:
 - clamshell, key fobs, wrist bands

• OMEC USA

- Located in Cleveland, Ohio area
- End-to-end card production capability
- Sample available starting in June 2024







OMEC Shanghai – Quick Facts

OMEC Shanghai (Shanghai Oriental Magnetic Card Engineering Co., Ltd)
 was established in 1994

- Full Capabilities, annual capacity of 150 million cards and 120 million dual interface inlays
 - 2,500 m² (27,000 sq. ft) of factory production space
 - 6 production lines for contactless and dual interface products



Capabilities – COB Packaging

- ISO 1000 cleanroom
- Capability to customize
 COB form factor for specific
 products





Capabilities – Printing

- Silk screen, offset, digital
- PVC, PET, ABS, PC, Teslin,
 PLA
- End-to-end color
 management to achieve ΔΕ
 < 2





Capabilities – Assembling

- Low Frequency, High Frequency, UHF, Combo
- Automatic end-to-end assembling from coil winding to inlay



Capabilities – Collating

- ISO 1000 clean room
- 1 fully automated line







Capabilities – Lamination

- 3 highly automated lamination machine codeveloped with vendor
 - PVC/R-PVC/C-PVC
 - PETE/PET-G
 - PC
 - PLA
 - Wide range of different composite options





Capabilities – Card Finishing

- Punching
- Stamping
- Visual Inspection



Capabilities – Dual Interface

- Dual interface inlay
- Printed antenna inlay available now
- Implant & Embedding
 - 4 production lines
 - Flex-bump
 - ACF







Capabilities – Programming & Personalization

- Low frequency, high frequency, all protocols.
- Secure server for key/data exchange
- Laser engraving
- DoD printing





OMEC USA Overview

- Located in Strongsville OH, currently under renovation (eta Feb. 2024)
 - Built upon learnings of our Shanghai factory
 - 1700m² (18,500 sq. ft) of factory production space
- Full Capabilities
 - From printing to programming
 - Highly automated
 - Improved intelligent manufacturing system





Capabilities Overview

- Digital printing w/ VDP
- Assembling
 - Automated LF/HF/Combo
 - Fully automatic dual interface inlay assembling
- Collating
 - 2 fully automatic line co-designed w/ vendor
 - Tightly couple's w/ lamination machines



Capabilities Overview – cont'd

- Lamination
 - 3 fully automatic line improved from Shanghai factory version
- Card finishing
 - 1 modular punching, inspection line
- Personalization/Programming
 - Custom designed machine w/ vendor
 - Programming for all LF/HF protocols and magstripe
 - Laser Engraving
 - DoD Printing
 - 2 side full personalization in 1 pass









Valid 5a.m. to 10 p.m., 7 days aweek.













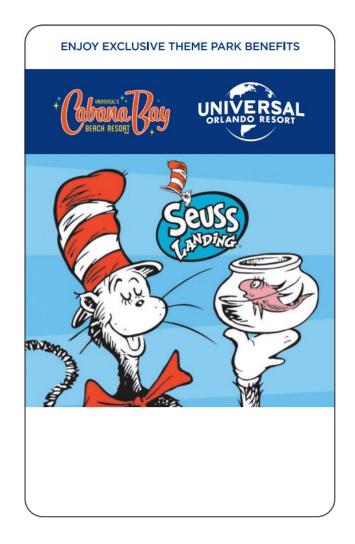


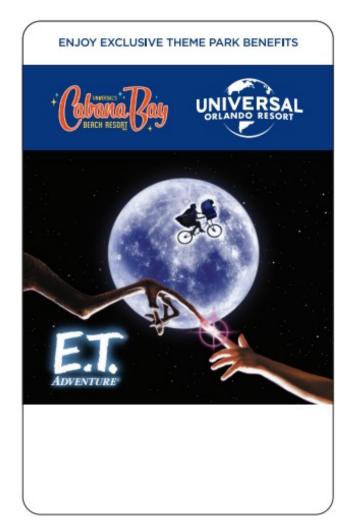


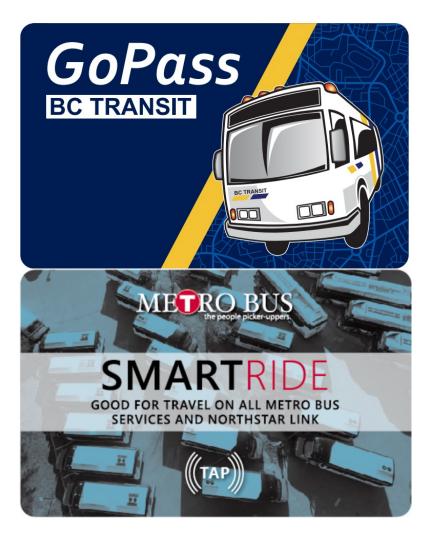








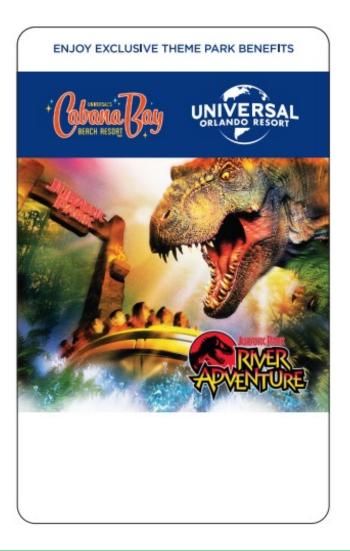














Thank you

Please check back in a few days when the site is up

